



DMN53D0LDW

DUAL N-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

Product Summary

| V _{(BR)DSS} | R _{DS(ON)} | I _D T _A = +25°C |
|----------------------|-------------------------------|--|
| 50V | 1.6Ω @ $V_{GS} = 10V$ | 360mA |
| | 2.5Ω @ V _{GS} = 4.5V | 250mA |

Description

This new generation MOSFET has been designed to minimize the on-state resistance ($R_{DS(ON)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power management functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc

Features

- Dual N-Channel MOSFET
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD protected to 2KV
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish annealed over Alloy 42 leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208⁽³⁾
- Terminal Connections: See Diagram
- Weight: 0.006 grams (approximate)

SOT363





Top View Internal Schematic

Top View

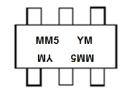
Ordering Information (Note 4)

| Part Number | Case | Packaging |
|---------------|--------|-------------------|
| DMN53D0LDW-7 | SOT363 | 3000/Tape & Reel |
| DMN53D0LDW-13 | SOT363 | 10000/Tape & Reel |

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



MM5 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: B = 2014) M = Month (ex: 9 = September)

Date Code Key

| Year | 201 | 4 | 2015 | | 2016 | 20 | 17 | 2018 | | 2019 | 2 | 2020 |
|-------|-----|-----|------|-----|------|-----|-----|------|-----|------|-----|------|
| Code | В | | С | | D | | Ξ | F | | G | | Н |
| Month | Jan | Feb | Mar | Apr | May | Jun | Jul | Aug | Sep | Oct | Nov | Dec |
| Code | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 0 | N | D |



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Value | Unit |
|------------------------|------------------|-------|------|
| Drain Source Voltage | V _{DSS} | 50 | V |
| Gate-Source Voltage | V _{GSS} | ±20 | V |
| Drain Current (Note 5) | I _D | 360 | mA |

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

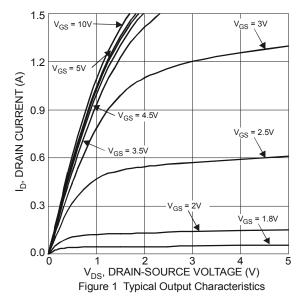
| Characteristic | Symbol | Value | Unit |
|--|-----------------------------------|-------------|------|
| Total Power Dissipation (Note 5) | P_{D} | 310 | mW |
| Thermal Resistance, Junction to Ambient (Note 5) | $R_{	hetaJA}$ | 411 | °C/W |
| Operating and Storage Temperature Range | T _J , T _{STG} | -55 to +150 | °C |

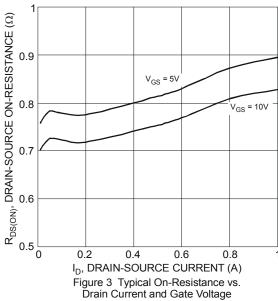
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition | |
|------------------------------------|----------------------|-----|-------------|-------------------|------|---|--|
| OFF CHARACTERISTICS (Note 6) | | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 50 | _ | _ | V | $V_{GS} = 0V, I_D = 250\mu A$ | |
| Zero Gate Voltage Drain Current | I _{DSS} | _ | _ | 1.0 | μΑ | V _{DS} = 50V, V _{GS} = 0V | |
| Gate-Body Leakage | I _{GSS} | _ | _ | 10 | μΑ | $V_{GS} = \pm 20V, V_{DS} = 0V$ | |
| ON CHARACTERISTICS (Note 6) | | | | | | | |
| Gate Threshold Voltage | V _{GS(th)} | 0.8 | _ | 1.5 | V | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | |
| Static Drain-Source On-Resistance | R _{DS (ON)} | | _ _ _ | 1.6 2.5 4.5 | Ω | $V_{GS} = 10V, I_D = 500mA$ $V_{GS} = 4.5V, I_D = 200mA$ $V_{GS} = 2.5V, I_D = 100mA$ | |
| Source-Drain Diode Forward Voltage | V _{SD} | _ | _ | 1.4 | V | $V_{GS} = 0V, I_S = 500mA$ | |
| DYNAMIC CHARACTERISTICS (Note 7) | | | | | | | |
| Input Capacitance | C _{iss} | _ | 46 | _ | pF | | |
| Output Capacitance | Coss | _ | 5.3 | _ | pF | $V_{DS} = 25V, V_{GS} = 0V$ f = 1.0MHz | |
| Reverse Transfer Capacitance | C _{rss} | _ | 4.0 | _ | pF | -1 - 1.0IVII IZ | |
| Total Gate Charge | Q_g | _ | 0.6 | _ | nC | \\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\\ | |
| Gate-Source Charge | Q_{gs} | _ | 0.2 | _ | nC | $V_{GS} = 4.5V, V_{DS} = 10V,$ $I_{D} = 250 \text{mA}$ | |
| Gate-Drain Charge | Q_{gd} | _ | 0.1 | _ | nC | 1D = 23011IA | |
| Turn-On Delay Time | t _{D(on)} | _ | 2.7 | _ | ns | | |
| Turn-On Rise Time | t _r | _ | 2.5 | _ | ns | $V_{DD} = 30V, V_{GS} = 10V,$ $R_G = 25\Omega, I_D = 200 \text{mA}$ | |
| Turn-Off Delay Time | t _{D(off)} | _ | 19 | _ | ns | | |
| Turn-Off Fall Time | t _f | _ | 11 | _ | ns | | |

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.6. Short duration pulse test used to minimize self-heating effect.7. Guaranteed by design. Not subject to product testing.







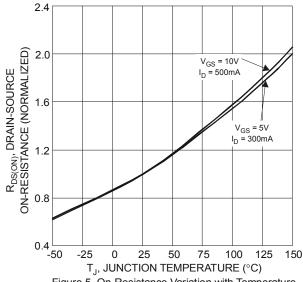
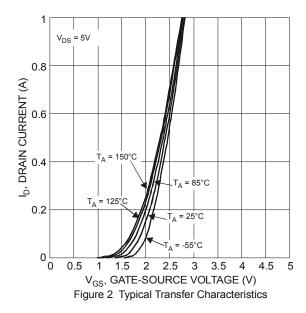
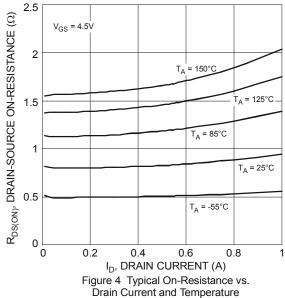


Figure 5 On-Resistance Variation with Temperature





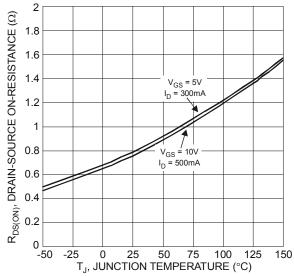


Figure 6 On-Resistance Variation with Temperature



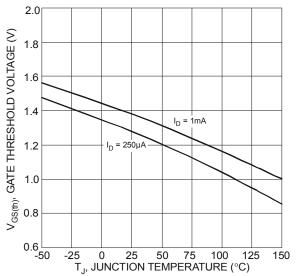
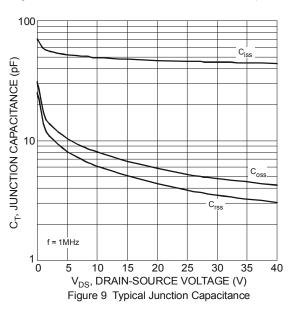
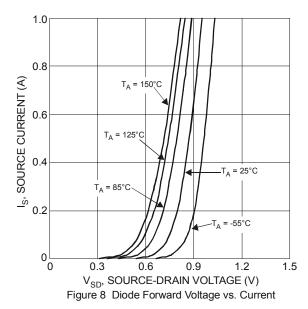
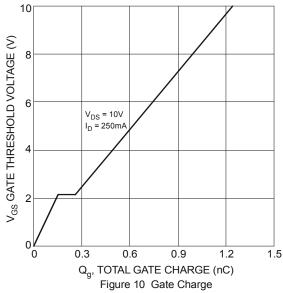


Figure 7 Gate Threshold Variation vs. Ambient Temperature

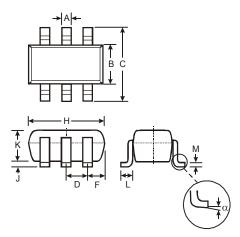






Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.

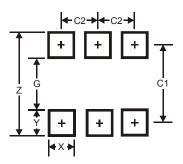


| | SOT363 | | | | | | | |
|-----|----------------------|---------|------|--|--|--|--|--|
| Dim | Min Max Ty | | | | | | | |
| Α | 0.10 | 0.30 | 0.25 | | | | | |
| В | 1.15 | 1.35 | 1.30 | | | | | |
| С | 2.00 | 2.20 | 2.10 | | | | | |
| D | | 0.65 Ty | p | | | | | |
| F | 0.40 0.45 0.42 | | | | | | | |
| Н | 1.80 | 2.20 | 2.15 | | | | | |
| J | 0 | 0.10 | 0.05 | | | | | |
| K | 0.90 | 1.00 | 1.00 | | | | | |
| L | 0.25 | 0.40 | 0.30 | | | | | |
| М | 0.10 | 0.22 | 0.11 | | | | | |
| α | 0° | 8° | - | | | | | |
| All | All Dimensions in mm | | | | | | | |



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| Z | 2.5 |
| G | 1.3 |
| Х | 0.42 |
| Υ | 0.6 |
| C1 | 1.9 |
| C2 | 0.65 |

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